

SSL2108 series

GreenChip drivers for LED lighting

Rev. 4 — 8 May 2012

Product data sheet

1. General description

The SSL2108 series is a range of high-voltage Integrated Circuits (ICs) for driving LED lamps in general lighting applications.

The main benefits of the product family are:

- Small Printed-Circuit Board (PCB) footprint, and compact solution
- High efficiency (up to 95 %)
- · Ease of integration
- Low electronic Bill Of Material (BOM)

The product family is made of ICs with a range of internal HV switches for easy power scaling.

The ICs work as boundary conduction mode converters, typically in buck configuration. The IC range has been designed to start up directly from the HV supply by an internal high-voltage current source. Thereafter, the dV/dt supply is used with capacitive coupling from the drain, or any other auxiliary supply. This functionality provides full flexibility in the application design. The IC consumes 1.3 mA of supply current with an internal clamp limiting the supply voltage.

The ICs provide accurate output current control with LED current accuracy within 5 %. The ICs can be operated using Pulse-Width Modulation (PWM) dimming and has many protection features including easy LED temperature feedback.

Remark: This data sheet covers the both the T and AT versions of the SSL21081, SSL21082, SSL21083 and SSL21084. Unless the version is explicitly stated, SSL2108XT refers to all T versions.

2. Features and benefits

- LED driver IC family driving strings of LEDs from a rectified mains supply
- High-efficiency switch mode buck driver product family:
 - ◆ Drivers with integrated 300 V (DC) (SSL21081 and SSL21082) or 600 V (DC) (SSL21083 and SSL21084) power switches
- Controller with power-efficient boundary conduction mode of operation with:
 - No reverse recovery losses in freewheel diode
 - Zero Current Switching (ZCS) for turn-on of switch
 - Zero voltage or valley switching for turn-on of switch
 - Minimal required inductance value and size



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- Direct PWM dimming possible
- Fast transient response through cycle-by-cycle current control:
 - ◆ Negligible AC mains ripple at LED current and minimal total capacitor value
 - ◆ No over or undershoots in the LED current
- No binning on LED forward voltage required
- Internal Protections:
 - UnderVoltage LockOut (UVLO)
 - ◆ Leading-Edge Blanking (LEB)
 - OverCurrent Protection (OCP)
 - Short-Winding Protection (SWP) SSL2108XT only
 - Internal OverTemperature Protection (OTP)
 - Brownout protection
 - Output Short Protection (OSP)
- Low component count (see Figure 4) LED driver solution:
 - No Schottky diode required due to ZCS
 - No dim switch and high-side driver required for PWM dimming
 - Easy external temperature protection with a single NTC resistor
 - Option for soft-start function
 - ◆ Compatible with wall switches with built-in indication light during standby¹
- IC lifetime easily matches or surpasses LED lamp lifetime

3. Applications

SSL2108 series products are intended for compact LED lighting applications with accurate fixed current output for single mains input voltages. Mains input voltages include 100 V (AC), 120 V (AC) and 230 V (AC). The output signal can be modulated using a PWM signal.

^{1.} The Hotaru switch is a well known wall switch with built-in light

4. Quick reference data

Table 1. Quick reference data

Parameter	Conditions	Min	Тур	Max	Unit
supply voltage	operating range	<u>[1]</u> 8	-	14	V
drain-source on-state resistance	SSL21083T/AT; SSL21084T/AT; $T_j = 25 ^{\circ}\text{C}$	4	5	6	Ω
	SSL21083T/AT; SSL21084T/AT; $T_j = 125 ^{\circ}\text{C}$	6	7.5	9	V
	SSL21081T/AT; SSL21082T/AT; $T_j = 25$ °C	2.05	2.3	2.55	
	SSL21081T/AT; SSL21082T/AT; $T_j = 125 ^{\circ}\text{C}$	3.05	3.45	3.85	
conversion frequency		-	-	200	kHz
current on pin DRAIN	SSL21083T/AT; SSL21084T/AT	-1	-	1	Α
	SSL21081T/AT; SSL21082T/AT	-2	-	2	Α
voltage on pin DRAIN	SSL21083T/AT; SSL21084T/AT	-0.4	-	600	V
	SSL21081T/AT; SSL21082T/AT	-0.4	-	300	V
	supply voltage drain-source on-state resistance conversion frequency current on pin DRAIN	supply voltage operating range drain-source on-state resistance $\begin{array}{ll} \text{SSL21083T/AT;} \\ \text{SSL21084T/AT;} \\ \text{T}_j = 25 ^{\circ}\text{C} \\ \text{SSL21084T/AT;} \\ \text{T}_j = 125 ^{\circ}\text{C} \\ \text{SSL21084T/AT;} \\ \text{T}_j = 125 ^{\circ}\text{C} \\ \text{SSL21082T/AT;} \\ \text{T}_j = 25 ^{\circ}\text{C} \\ \text{SSL21082T/AT;} \\ \text{T}_j = 25 ^{\circ}\text{C} \\ \text{SSL21082T/AT;} \\ \text{T}_j = 125 ^{\circ}\text{C} \\ \text{SSL21082T/AT;} \\ \text{T}_j = 125 ^{\circ}\text{C} \\ \text{Conversion frequency} \\ \text{current on pin DRAIN} \\ \text{SSL21083T/AT;} \\ \text{SSL21084T/AT} \\ \text{Voltage on pin DRAIN} \\ \text{SSL21083T/AT;} \\ \text{SSL21084T/AT} \\ \text{SSL21084T/AT} \\ \text{SSL21084T/AT;} \\ SSL21084$	supply voltage operating range drain-source on-state resistance $\begin{array}{lll} & SSL21083T/AT; & 4 \\ & SSL21084T/AT; & 5 \\ & SL21083T/AT; & 6 \\ & SSL21083T/AT; & 6 \\ & SSL21084T/AT; & 7_j = 125 ^{\circ}C \\ & SSL21081T/AT; & 2.05 \\ & SSL21082T/AT; & 7_j = 25 ^{\circ}C \\ & SSL21082T/AT; & 3.05 \\ & SSL21082T/AT; & 3.05 \\ & SSL21082T/AT; & -1 \\ & SSL21084T/AT & -1 \\ & SSL21084T/AT & -1 \\ & SSL21082T/AT & -2 \\ & SSL21082T/AT & -2 \\ & SSL21082T/AT & -0.4 \\ & SSL21084T/AT & -0.4 \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

^[1] The maximum operating voltage at VCC can exceed 14 V when determined by the IC using the DVDT supply.

5. Ordering information

Table 2. Ordering information

Type number	Package							
	Name	Description	Version					
SSL21081T	SO8	plastic small package outline body; 8 leads; body width	SOT96-1					
SSL21083T		3.9 mm						
SSL21081AT								
SSL21083AT								
SSL21082T	SO12	plastic small package outline body; 12 leads; body width	SOT1196-1					
SSL21084T		3.9 mm						
SSL21082AT								
SSL21084AT								

5.1 Ordering options

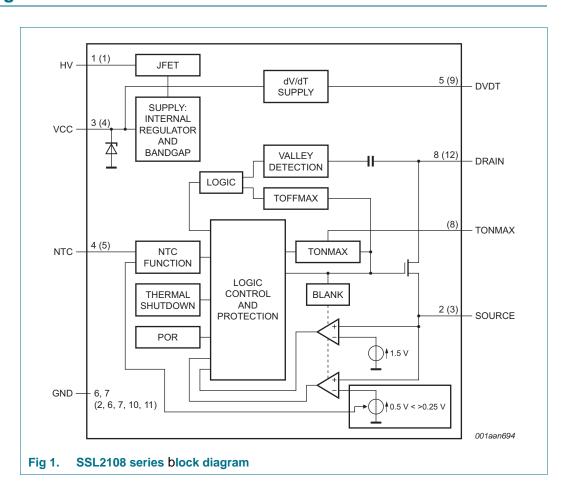
Remark: All voltages are in V (AC) unless otherwise specified.

Table 3. Ordering options

SSL2108 series variants	Input voltage	Internal MOSFET characteristics	Package	Brownout protection selectable
SSL21081T	100 V; 120 V	300 V (DC); 2 Ω	SO8	no
SSL21081AT				
SSL21082T			SO12	yes
SSL21082AT				
SSL21083T	100 V; 120 V;	600 V (DC); 5 Ω	SO8	no
SSL21083AT	230 V			
SSL21084T			SO12	yes
SSL21084AT	-			

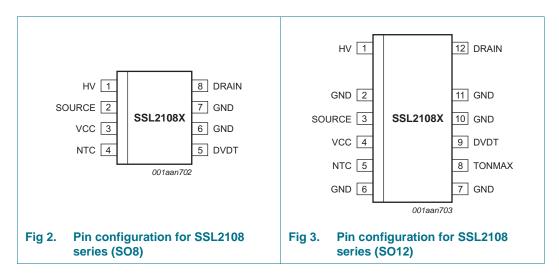
^[1] The SO12 package variants have more so called fused leads than the SO8 variants and can be used when higher output power is required.

6. Block diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

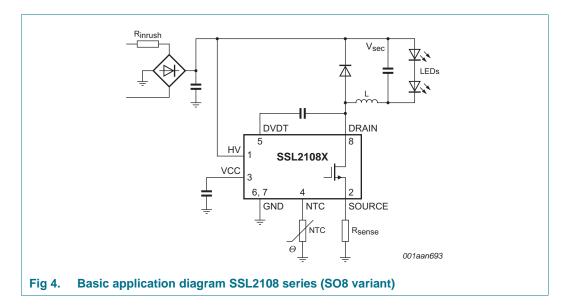
Table 4. Pin description

Symbol	Pin (SO8)	Pin (SO12)	Description
HV	1	1	high-voltage supply pin
SOURCE	2	3	low-side internal switch
VCC	3	4	supply voltage
NTC	4	5	LED temperature protection input
GND	6,7	2,6,7,10,11	ground
DVDT	5	9	AC supply pin
TONMAX	-	8	brownout protection timer input
DRAIN	8	12	high-side internal switch

8. Functional description

8.1 Converter operation

The converter in the SSL2108 series is a Boundary Conduction Mode (BCM), peak current controlled system. For the basic application diagram see <u>Figure 4</u>, for the waveforms see <u>Figure 5</u>. This converter type operates at the boundary between continuous and discontinuous mode. Energy is stored in inductor L each period that the switch is on. The inductor current I_L is zero when the internal MOSFET switch is switched on. Thereafter, the amplitude of the current build-up in L is proportional to $V_{IN} - V_{OUT}$ and the time that the internal MOSFET switch is on. When the internal MOSFET switch is switched off, the current continues to flow through the freewheel diode and the output capacitor. The current then falls at a rate proportional to the value of V_{OUT} . The LED current I_{LED} is almost equal to half the peak switch current. A new cycle is started, as soon as the inductor current I_L is zero.



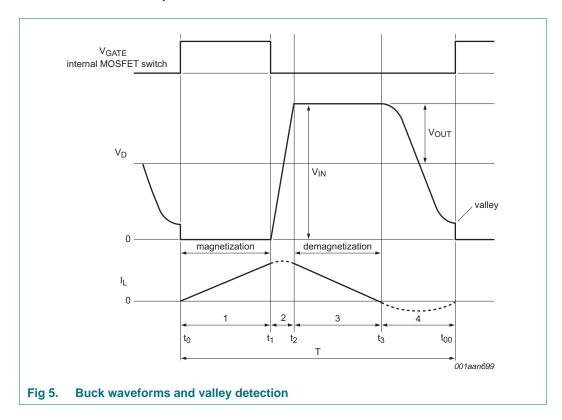
8.2 Conversion frequency

The conversion frequency must be limited to below 200 kHz. Therefore, select an inductance value so that the conversion frequency is always within limits, given the supply voltage, LED voltage and component spread.

8.3 Valley detection

A new cycle is started when the primary switch is switched on (see Figure 5). Following time t_1 , when the peak current is detected on the SOURCE pin, the switch is turned off and the secondary stroke starts (3). When the secondary stroke is complete and the coil current at t_3 equals zero, the drain voltage starts to oscillate around the $V_{IN} - V_{OUT}$ level. The amplitude equals V_{OUT} . A special feature, called valley detection is an integrated part of the SSL2108 series circuitry. Dedicated built-in circuitry connected to the DRAIN pin, senses when the voltage on the drain of the switch has reached its lowest value. The next cycle is then started and as a result the capacitive switching losses are reduced.

A valley is detected and accepted if both the frequency of the oscillations and the voltage swing are within the range specified (f_{ring} and $\Delta V_{vrec(min)}$) for detection. If a valid valley is not detected, the secondary stroke is continued until the maximum off-time ($t_{off(high)}$) is reached, then the next cycle is started.



8.4 Protective features

The IC has the following protective features:

- UnderVoltage LockOut (UVLO)
- Leading-Edge Blanking (LEB)
- OverCurrent Protection (OCP)
- Internal OverTemperature Protection (OTP)
- Brownout protection
- Short-Winding Protection (SWP) SSL2108XT only
- Output Short Protection (OSP)
- LED overtemperature control and protection

The SWP and the OSP are latched protections. These protections cause the IC to halt until a reset (a result of power cycling) is executed. When V_{CC} drops lower than $V_{CC(rst)}$, the IC resets the latch protection mode. The internal OTP and LED over temperature protections are safe-restart protections. The IC halts, causing V_{CC} to fall lower than $V_{CC(stop)}$, and instigates start-up. Switching starts only when no fault condition exists.

8.4.1 UnderVoltage LockOut (UVLO)

When the voltage on the VCC pin drops lower than $V_{CC(stop)}$, the IC stops switching. An attempt is then made to restart by supplying V_{CC} from the HV pin voltage.

8.4.2 Leading-Edge Blanking (LEB)

To prevent false detection of the short-winding or overcurrent, a blanking time following switch-on is implemented. When the internal MOSFET switch turns on there can be a short current spike due to capacitive discharge of voltage over the drain and source. During the LEB time (t_{leb}) , the spike is disregarded.

8.4.3 OverCurrent Protection (OCP)

The SSL2108 series contains a highly accurate peak current detector. It triggers when the voltage at the SOURCE pin reaches the peak-level $V_{th(ocp)SOURCE}$. The current through the switch is sensed using a resistor connected to the SOURCE pin. The sense circuit is activated following LEB time t_{leb} . As the LED current is half the peak current (by design), it automatically provides protection for maximum LED current during operation. There is a propagation delay between overcurrent detection and the actual closure of the switch $t_{d(ocp-swoff)}$. Due to the delay, the actual peak current is slightly higher than the OCP level set by the resistor in series to the SOURCE pin.

8.4.4 OverTemperature Protection (OTP)

When the internal OTP function is triggered at a certain IC temperature $(T_{th(act)otp})$, the converter stops operating. The safe-restart protection is triggered and the IC restarts again with switching resuming when the IC temperature drops lower than $T_{th(rel)otp}$.

8.4.5 Brownout protection

Brownout protection is designed to limit the lamp power when the input voltage drops close to the output voltage level. Since the input power has to remain constant, the input current would otherwise increase to a level that is too large for the input circuitry. For the SSL2108 series, there is a maximum limit on the on-time of the switch $t_{on(high)}$. The rate of current rise in the coil during the on-phase is proportional to the difference between input voltage and output voltage. Therefore, the peak current cannot be reached before $t_{on(high)}$ and as a result the average output current to the LEDs is reduced.

Using the SO12 package, the $t_{on(high)}$ can be lowered by connecting a capacitor to the TONMAX pin. The external capacitor is charged during the primary stroke with I_{TONMAX} . If V_{TONMAX} level is reached before the $t_{on(high)}$ time, the switch is turned off and the secondary stroke starts. When no capacitor is connected to the pin, V_{TONMAX} is reached quickly, shorter than the minimum limit of one microsecond. In this case, or in case the TONMAX pin is grounded, the internal time constant, $t_{on(high)}$ determines the maximum on-time.

8.4.6 Short-Winding Protection (SWP) SSL2108XT only

SWP activates if there is a steep rising current through the MOSFET and thus through the external resistor connected to the SOURCE pin. This current can occur when there is a short from the freewheel diode. Additionally, it occurs due to a small/shorted inductor between the input voltage and the DRAIN pin. If the voltage on the SOURCE pin is greater than 1.5 V, latched protection is triggered following LEB time t_{leb} . In addition, if V_{CC} drops lower than $V_{CC(rst)}$ the IC resets the latched protection mode.

8.4.7 Output Short Protection (OSP)

During the second stroke (switch-of time), if a valley is not detected within the off-time limit $(t_{off(high)})$, then typically the output voltage is less than the minimum limit allowed in the application. This condition can occur either during starting up or due to a short. A timer is started when $t_{off(high)}$ is detected, and is stopped only if a valid valley-detection occurs in one of the subsequent cycles. If no valley is detected for $t_{det(sc)}$, it is concluded that a real short-circuit exists and not start-up. The IC enters latched protection. If V_{CC} drops lower than $V_{CC(rst)}$, the IC resets the latched protection mode. During PWM dimming, the OSP timer is paused during the off-cycle of the PWM signal.

8.5 VCC supply

The SSL2108 series can be supplied using three methods:

- Under normal operation, the voltage swing on the DVDT pin is rectified within the IC providing current towards the VCC pin
- At start-up, there is an internal current source connected to the HV pin. The current source provides internal power until either the dV/dt supply or an external current on the VCC pin provides the supply
- An external voltage source can be connected to the VCC pin

The IC starts up when the voltage at the VCC pin is higher than $V_{CC(startup)}$. The IC locks out (stops switching) when the voltage at the VCC pin is lower than $V_{CC(stop)}$. The hysteresis between the start and stop levels allows the IC to be supplied by a buffer capacitor until the dV/dt supply is settled. The SSL2108 series has an internal V_{CC} clamp, which is an internal active Zener (or shunt regulator). This internal active Zener limits the voltage on the supply VCC pin to the maximum value of V_{CC} . If the maximum current of the dV/dt supply minus the current consumption of the IC (determined by the load on the gate drivers), is lower than the maximum value of I_{DD} no external Zener diode is needed in the dV/dt supply circuit.

8.6 DVDT supply

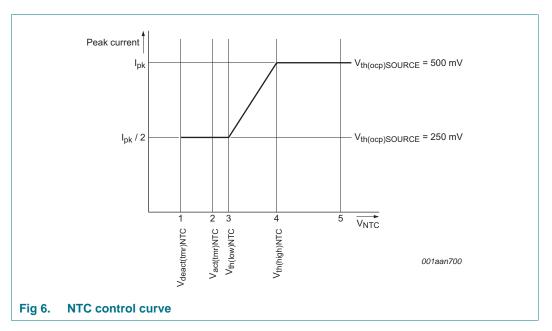
The DVDT pin is connected to an internal single-sided rectification stage. When an alternating voltage with sufficient amplitude is supplied to the pin, the IC can be powered without any other external power connection. This solution provides an effective method to prevent the additional high-power losses, which would result if a regulator were used for continuously powering the IC. Unlike an auxiliary supply, additional inductor windings are not needed.

8.7 VCC regulator

During supply dips, the input voltage can drop too low to supply the required IC current through the DVDT pin. Under these conditions, if the VCC voltage drops lower than $V_{CC(swon)reg}$ level, another regulator with a current capability of up to $I_{sup(high)HV}$ is started. The job of the regulator is to fill in the required supply current, which the DVDT supply does not deliver, thus preventing the IC going into UVLO. When the VCC voltage is higher than $V_{CC(swon)reg}$ level, the regulator is turned off.

8.8 NTC functionality and PWM dimming

The NTC pin can be used as a control method for LED thermal protection. Alternatively, the pin can be used as an input to disable/enable light output using a digital signal (PWM dimming). The pin has an internal current source that generates the current of $I_{offset(NTC)}$. An NTC resistor to monitor the LED temperature can be directly connected to the NTC pin. Depending on the resistance value and the corresponding voltage on the NTC pin, the converter reacts as shown in Figure 6.



When the voltage on the NTC pin is higher than $V_{th(high)NTC}$ see <u>Figure 6</u> (4), the converter delivers nominal output current. When the voltage is lower than this level, the peak current is gradually reduced until $V_{th(low)NTC}$ is reached, see <u>Figure 6</u> (3). The peak current is now half the peak current of nominal operation. When $V_{act(tmr)NTC}$ is passed, see <u>Figure 6</u> (2) a timer starts to run to distinguish between the following situations:

- If the low-level V_{deact(tmr)NTC} is not reached within time t_{to(deact)NTC}, <u>Figure 6</u> (1) LED overtemperature is detected. The IC stops switching and attempts to restart from the HV pin voltage. Restart takes place when the voltage on NTC pin is higher than V_{th(high)NTC}, see <u>Figure 6</u> (4). It is assumed that the reduction in peak current did not result in a lower NTC temperature and LED OTP is activated.
- If the low-level V_{deact(tmr)NTC} is reached within the time t_{to(deact)NTC}, Figure 6 (1) it is assumed that the pin is pulled down externally. The restart function is not triggered. Instead, the output current is reduced to zero. PWM dimming can be implemented this way. The output current rises again when the voltage is higher than V_{deact(tmr)NTC}.

8.8.1 Soft-start function

The NTC pin can be used to make a soft start function. During switch-on, the level on the NTC pin is low. By connecting a capacitor (in parallel with the NTC resistor), a time constant can be defined. The time constant causes the level on the NTC pin to increase slowly. When passing level $V_{th(low)NTC}$ Figure 6 (3), the convertor starts with half of the maximum current. The output current slowly increases to maximum when $V_{th(high)NTC}$ Figure 6 (4) is reached.

8.9 Heat sink

For SSL2108 series applications, the copper of the PCB acts as the heat sink. The SSL2108 series (SO12) uses thermal leads (pins 2, 6, 10 and 11) for enhanced heat transfer from die to the PCB copper heat sink. The thermal lead connection can drastically reduce thermal resistance.

<u>Equation 1</u> shows the relation between the maximum allowable power dissipation P and the thermal resistance from junction to ambient.

$$R_{th(i-a)} = (T_{i(max)} - T_{amb})/P (1)$$

Where:

 $R_{th(j-a)}$ = thermal resistance from junction to ambient

 $T_{j(max)}$ = maximum junction temperature

T_{amb} = ambient temperature

P = power dissipation

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
General					
SR	slew rate	on pin DRAIN	-5	+5	V/ns
f _{conv}	conversion frequency		-	200	kHz
P _{tot}	total power dissipation	SO8 package	-	0.6	W
		SO12 package	-	1	W
T _{amb}	ambient temperature		-40	+125	°C
Tj	junction temperature		-40	+150	°C
T _{stg}	storage temperature		-55	+150	°C
Voltages					
V _{CC}	supply voltage	continuous	<u>[1]</u> –0.4	+14	V
V _{DRAIN}	voltage on pin DRAIN	600 V (DC) version	-0.4	+600	V
		300 V (DC) version	-0.4	+300	V
V_{HV}	voltage on pin HV	current limited	-0.4	+600	V
V _{SOURCE}	voltage on pin SOURCE	current limited	-0.4	+5.2	V
V _{NTC}	voltage on pin NTC	current limited	-0.4	+5.2	V
V_{TONMAX}	voltage on pin TONMAX	current limited	-0.4	+5.2	V
Currents					
I_{DD}	supply current	at pin VCC	<u>[1]</u> _	20	mA
I _{DRAIN}	current on pin DRAIN	600 V (DC) version	-1	+1	Α
		300 V (DC) version	-2	+2	Α
I _{SOURCE}	current on pin SOURCE	600 V (DC) version	-1	+1	Α
		300 V (DC) version	-2	+2	Α
I_{DVDT}	current on pin DVDT	duration 20 μs maximum	-	1.3	Α
V_{ESD}	electrostatic discharge voltage	human body model; (for all pins except DRAIN and HV)	[2] –2	+2	KV
		human body model for DRAIN and HV	-1	+1	KV
		charged device	<u>[3]</u> –500	+500	V

^[1] An internal clamp sets the supply voltage and current limits.

^[2] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 k Ω series resistor.

^[3] Charged device model: equivalent to charging the IC up to 1 kV and the subsequent discharging of each pin down to 0 V over a 1 Ω resistor.

10. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; SO8 package, PCB: 2 cm \times 3 cm, 2-layer, 35 μ m Cu per layer	142	K/W
		in free air; SO12 package; PCB: 2 cm \times 3 cm, 2-layer, 35 μ m Cu per layer	121	K/W
		in free air; SO8 package; PCB: JEDEC 2s2p	72	K/W
		in free air; SO12 package; PCB: JEDEC 2s2p	53	K/W
$\Psi_{\text{j-top}}$	thermal resistance from junction to top	top package temperature measured at the warmest point on top of the case; SO8 package	3.4	K/W
		top package temperature measured at the warmest point on top of the case; SO12 package	4.7	K/W

11. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
High-voltage						
I _{leak(DRAIN)}	leakage current on pin DRAIN	V _{DRAIN} = 600 V (DC)	-	-	10	μΑ
		V _{DRAIN} = 300 V (DC)	-	-	10	μΑ
I _{leak(HV)}	leakage current on pin HV	$V_{HV} = 600 \text{ V (DC)}$	-	-	30	μΑ
		$V_{HV} = 300 \text{ V (DC)}$	-	30		μΑ
Supply						
V_{CC}	supply voltage	operating range	[1] 8	-	14	V
$V_{CC(startup)}$	start-up supply voltage		11	12	13	V
$V_{CC(stop)}$	stop supply voltage		8	9	10	V
$V_{CC(hys)}$	hysteresis of supply voltage	between $V_{CC(startup)}$ and $V_{CC(stop)}$	2	-	-	V
$V_{CC(rst)}$	reset supply voltage		4.5	5	5.5	V
$V_{CC(swon)reg}$	regulator switch-on supply voltage	insufficient dV/dt supply	8.75	9.25	9.75	V
V _{CC(swoff)reg}	regulator switch-off supply voltage	insufficient dV/dt supply	9.5	10	10.5	V
V _{CC(reg)hys}	regulator supply voltage hysteresis	$V_{CC(swoff)reg} - V_{CC(swon)reg}$	0.3	-	-	V
V _{CC(regswon-stop)}	supply voltage difference between regulator switch-on and stop	$V_{CC(swon)reg} - V_{CC(stop)}$	0.3	-	-	V
Consumption						
I _{stb(HV)}	standby current on pin HV	during start-up or in protection; $V_{HV} = 100 \text{ V}$	300	350	400	μА
I _{CC}	supply current	normal operation	-	1.3	-	mA

 Table 7.
 Characteristics ...continued

Symbol	Parameter	Conditions		Min	Tvn	Max	Unit
-	Parameter	Conditions		IVIII	Тур	IVIAX	Unit
Capability	high oundly assessed as a first N/	Ctandhu V 40 V		1	1.0	1.0	n= ^
I _{sup(high)} HV	high supply current on pin HV	Standby: $V_{HV} = 40 \text{ V}$; $VCC < V_{CC(stop)}$		1	1.3	1.6	mA
		Regulator On: V _{HV} = 40 V; VCC < V _{CC(swon)reg} after start-up		2	2.3	2.6	mA
Current and S\	WP						
$V_{th(ocp)SOURCE}$	overcurrent protection threshold	$\Delta V/\Delta t = 0.1 V/\mu s$		480	500	520	mV
	voltage on pin SOURCE	$\Delta V/\Delta t = 0.1 \text{ V/}\mu\text{s}; \text{ V}_{\text{NTC}} = 0.325 \text{ V}$		230	250	270	mV
t _{d(ocp-swoff)}	delay time from overcurrent protection to switch-off	$\Delta V/\Delta t = 0.1 V/\mu s$		-	75	100	ns
t _{leb}	leading edge blanking time	overcurrent protection		260	300	340	ns
		short-winding protection		210	250	290	ns
Δt_{leb}	leading edge blanking time difference	between t _{leb} for overcurrent protection and short-winding protection		30	50	-	ns
$V_{th(swp)}$ SOURCE	short-winding protection threshold voltage on pin SOURCE	SSL2108XT only		1.4	1.5	1.6	V
Valley detection	n						
$(\Delta V/\Delta t)_{Vrec}$	valley recognition voltage change with time	on pin DRAIN		-30	-20	-10	V/μs
f _{ring}	ringing frequency		[2]	200	550	1000	kHz
$\Delta V_{\text{vrec(min)}}$	minimum valley recognition voltage difference	voltage drop on pin DRAIN		15	20	25	V
t _{d(vrec-swon)}	valley recognition to switch-on delay time			-	100	-	ns
Brownout dete	ection						
$V_{th(TONMAX)}$	threshold voltage on pin TONMAX			3.75	4	4.25	V
I _{offset(TONMAX)}	offset current on pin TONMAX			-37	-43	-48	μΑ
t _{on(high)}	high on-time			12.5	15	17.5	μS
MOSFET outpu	ut stage						
V _{BR(DRAIN)}	breakdown voltage on pin DRAIN	600 V (DC) version; $T_j > 0$ °C		600	-	-	V
		300 V (DC) version; $T_j > 0$ °C		300	-	-	V
R _{DSon}	drain-source on-state resistance	600 V (DC) version; $T_j = 25 ^{\circ}\text{C}$		4	5	6	Ω
		600 V (DC) version; $T_j = 125$ °C		6	7.5	9	Ω
		300 V (DC) version; $T_j = 25 ^{\circ}\text{C}$		2.05	2.3	2.55	Ω
		300 V (DC) version; T _j = 125 °C		3.05	3.45	3.85	Ω
$(dV/dt)_{f(DRAIN)}$	fall rate of change of voltage on pin DRAIN	300 V (DC) version; C_{DRAIN} = 150 pF, R_{SOURCE} = 2.2 Ω	[2]	-	1.2	-	V/ns
		600 V (DC) version; $C_{DRAIN} = 75 \text{ pF}$; $R_{SOURCE} = 1.2 \Omega$		-	1.5	-	V/ns

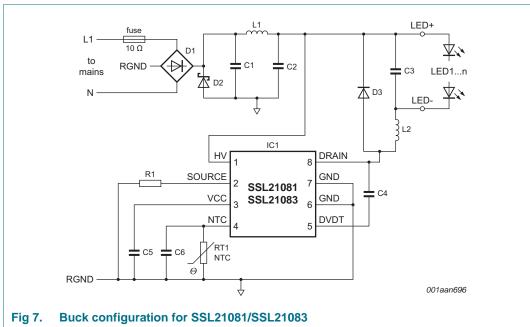
Table 7. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NTC function	ality					
$V_{th(high)\text{NTC}}$	high threshold voltage on pin NTC		0.47	0.5	0.53	V
$V_{th(low)NTC}$	low threshold voltage on pin NTC		0.325	0.35	0.375	V
$V_{act(tmr)NTC}$	timer activation voltage on pin NTC		0.26	0.29	0.325	V
$V_{\text{deact(tmr)NTC}}$	timer deactivation voltage on pin NTC		0.17	0.2	0.23	V
t _{to(deact)} NTC	deactivation time-out time on pin NTC		33	46	59	μS
I _{offset(NTC)}	offset current on pin NTC		-	-47	-	μΑ
OSP						
t _{det(sc)}	short-circuit detection time		16	20	24	ms
t _{off(high)}	high off-time		30	36	42	μS
Temperature	protections					
$T_{th(act)otp}$	overtemperature protection activation threshold temperature		160	170	180	°C
T _{th(rel)otp}	overtemperature protection release threshold temperature		90	100	110	°C

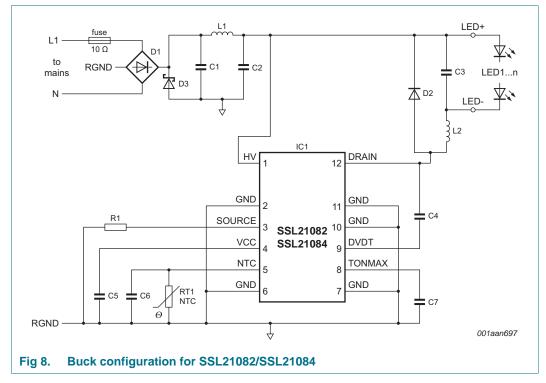
^[1] The maximum operating voltage at VCC can exceed 14 V when determined by the IC using the DVDT supply.

^[2] This parameter is not tested during production, by design it is guaranteed.

12. SSL2108 series buck configuration





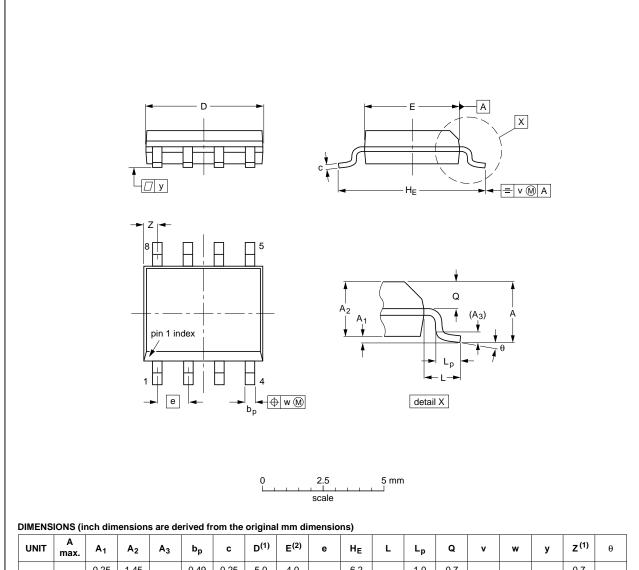


Further application information can be found in the SSL2108 series application note.

13. Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	ď	٧	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	5.0 4.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.20 0.19	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE		REFER	ENCES		EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEDEC JEITA		PROJECTION	ISSUE DATE	
SOT96-1	076E03	MS-012				99-12-27 03-02-18	

Fig 9. Package outline SOT96-1 (SOT8)

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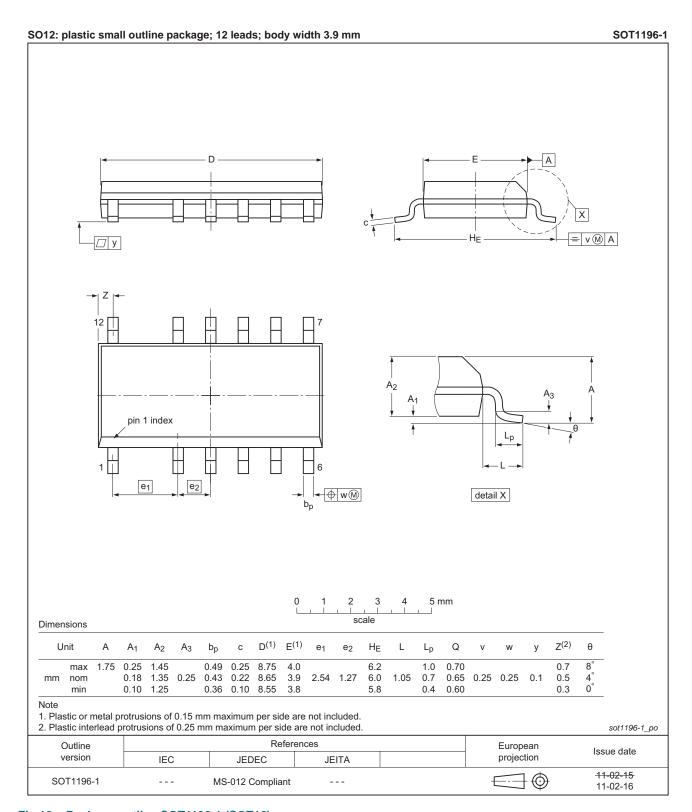


Fig 10. Package outline SOT1196-1 (SOT12)

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14. Abbreviations

Table 8. Abbreviations

Acronym	Description
BCM	Boundary Conduction Mode
BOM	Bill Of Materials
LED	Light Emitting Diode
LEB	Leading-Edge Blanking
MOSFET	Metal-Oxide Semiconductor Field-Effect Transistor
OCP	OverCurrent Protection
OSP	Output Short Protection
OTP	OverTemperature Protection
PCB	Printed-Circuit Board
PWM	Pulse-Width Modulation
SWP	Short-Winding Protection
UVLO	UnderVoltage LockOut
ZCS	Zero Current Switching

15. References

[1] AN11040 — Drivers for LED lighting - application note

16. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
SSL2108_SER v.4	20120508	Product data sheet	-	SSL21081T_2T_3T_4T v.3.1		
Modifications:	• SSL21081	AT, SSL21082AT, SSL2108	3AT and SSL2108	34AT added.		
 Minor text changes throughout the data sheet. 						
SSL21081T_2T_3T_4T v.3.1	20120222	Product data sheet	-	SSL21081T_2T_3T_4T v.3		
SSL21081T_2T_3T_4T v.3	20120214	Product data sheet	-	SSL21081T_2T_3T_4T v.2		
SSL21081T_2T_3T_4T v.2	20111206	Preliminary data sheet	-	SSL2108X v.1		
SSL2108X v.1	20110909	Preliminary data sheet	-	-		

17. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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SSL2108 series

GreenChip drivers for LED lighting

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